

LCD EMI Filter Array with ESD Protection

CM1405

Features

- · Eight channels of EMI filtering
- 30kV ESD protection on each channel (IEC 61000-4-2 Level 4, contact discharge)
- 30kV ESD protection on each channel (HBM)
- Better than 35dB of attenuation at 800-2700MHz
- Chip Scale Package features extremely low lead inductance for optimum filter and ESD performance
- 20-bump, 4.000mm x 1.458mm footprint Chip Scale Package
- OptiGuard[™] coated version available for improved reliability at assembly
- RoHS-compliant, lead-free finishing

Applications

- · LCD data lines in mobile handsets
- EMI filtering & ESD protection for high-speed I/O ports
- EMI filtering for high-speed data lines
- Wireless handsets
- Cell phones
- Notebook computers
- PDAs / Handheld PCs

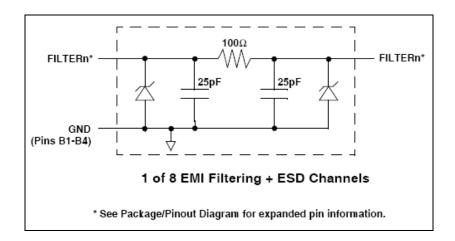
Product Description

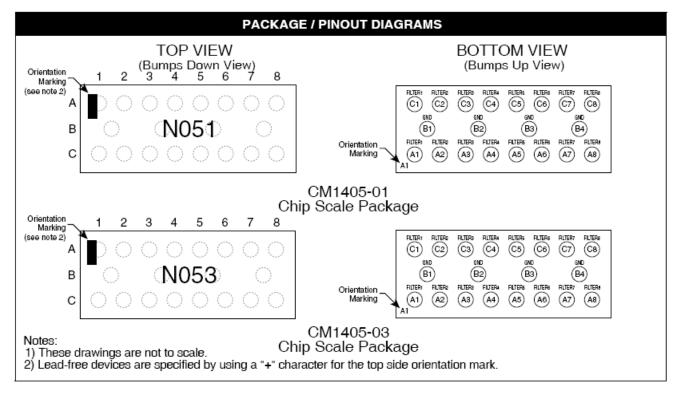
California Micro Device's CM1405 is an EMI filter array with ESD protection, which integrates eight Pifilters (C-R-C). The CM1405 has component values of 25pF-100W-25pF. The parts include avalanche-type ESD diodes on every pin, which provide a very high level of protection for sensitive electronic components that may be subjected to electrostatic discharge (ESD). The ESD diodes connected to the filter ports safely dissipate ESD strikes of •30kV, exceeding the maximum requirement of the IEC61000-4-2 international standard. Using the MIL-STD-883 (Method 3015) specification for Human Body Model (HBM) ESD, the pins are protected for contact discharges at greater than •30kV.

This device is particularly well-suited for portable electronics (e.g. mobile handsets, PDAs, notebook computers) because of its small package and easy-to-use pin assignments. In particular, the CM1405 is ideal for EMI filtering and protecting data lines from ESD for the LCD display in mobile handsets. The CM1405-03 incorporates *OptiGuard*ā coating which results in improved reliability at assembly and is available in space-saving, low-profile chip-scale packages with RoHS-compliant, lead-free finishing.

The CM1400-03 incorporates *OptiGuard™* coating which results in improved reliability at assembly. The CM1400-03 is available in a space-saving, low-profile chip scale package with RoHS compliant lead-free finishing.

Block Diagram





| PIN DESCRIPTIONS | | | | | | | | | | |
|------------------|---------|------------------|--|--------|---------|------------------|--|--|--|--|
| PIN(s) | NAME | DESCRIPTION | | PIN(s) | NAME | DESCRIPTION | | | | |
| A1 | FILTER1 | Filter Channel 1 | | C1 | FILTER1 | Filter Channel 1 | | | | |
| A2 | FILTER2 | Filter Channel 2 | | C2 | FILTER2 | Filter Channel 2 | | | | |
| А3 | FILTER3 | Filter Channel 3 | | С3 | FILTER3 | Filter Channel 3 | | | | |
| A4 | FILTER4 | Filter Channel 4 | | C4 | FILTER4 | Filter Channel 4 | | | | |
| A5 | FILTER5 | Filter Channel 5 | | C5 | FILTER5 | Filter Channel 5 | | | | |
| A6 | FILTER6 | Filter Channel 6 | | C6 | FILTER6 | Filter Channel 6 | | | | |
| A7 | FILTER7 | Filter Channel 7 | | C7 | FILTER7 | Filter Channel 7 | | | | |
| A8 | FILTER8 | Filter Channel 8 | | C8 | FILTER8 | Filter Channel 8 | | | | |
| B1-B4 | GND | Device Ground | | | | | | | | |

Ordering Information

| PART NUMBERING INFORMATION | | | | | | | | | | | |
|----------------------------|-----|--------------------------------------|--|--------------------------------------|-----------------|--------------------------------------|-----------------|--------------------------------------|-----------------|--|--|
| | | | Standa | rd Finish | | | Lead-fre | e Finish² | | | |
| | | No Coat | No Coating Optiguard [™] Coated | | | -No Coating Optiguard™ Coated | | | | | |
| Bumps | PKG | Ordering Part Number ¹ | Part Marking | Ordering Part Number ¹ | Part Marking | Ordering Part Number ¹ | Part Marking | Ordering Part Number ¹ | Part Marking | | |
| 20 | CSP | CM1405-01CS | N051 | CM1405-03CS | N053 | CM1405-01CP | N051 | CM1405-03CP | N053 | | |

Note 1: Parts are shipped in Tape & Reel form unless otherwise specified.

Note 2: Lead-free devices are specified by using a "+" character for the top side orientation mark.

Specifications

| ABSOLUTE MAXIMUM RATINGS | | | | | | |
|---------------------------|-------------|-------|--|--|--|--|
| PARAMETER | RATING | UNITS | | | | |
| Storage Temperature Range | -65 to +150 | °C | | | | |
| DC Power per Resistor | 100 | mW | | | | |
| DC Package Power Rating | 500 | mW | | | | |

| STANDARD OPERATING CONDITIONS | | | | | | | |
|-------------------------------|------------|-------|--|--|--|--|--|
| PARAMETER | RATING | UNITS | | | | | |
| Operating Temperature Range | -40 to +85 | °C | | | | | |

| | ELECTRICAL OPERATING CHARACTERISTICS (SEE NOTE 1) | | | | | | | | | | |
|-----------------------|--|--|-------------|-------------|-------------|----------|--|--|--|--|--|
| SYMBOL | PARAMETER | CONDITIONS | MIN | TYP | MAX | UNITS | | | | | |
| R | Resistance | | 80 | 100 | 120 | Ω | | | | | |
| С | Capacitance | At 2.5V DC, 1MHz, 30mV AC | 20 | 25 | 30 | pF | | | | | |
| V _{DIODE} | Diode Standoff Voltage | $I_{\text{DIODE}} = 10 \mu A$ | | 6.0 | | V | | | | | |
| I _{LEAK} | Diode Leakage Current (reverse bias) | $V_{\text{DIODE}} = +3.3V$ | | 0.1 | 1 | μА | | | | | |
| V _{SIG} | Signal Voltage Positive Clamp Negative Clamp | $I_{LOAD} = 10\text{mA}$ $I_{LOAD} = -10\text{mA}$ | 5.6 -1.5 | 6.8 -0.8 | 9.0 -0.4 | V V | | | | | |
| V _{ESD} | In-system ESD Withstand Voltage a) Human Body Model, MIL-STD-883, Method 3015 b) Contact Discharge per IEC 61000-4-2 Level 4 | Note 2 | 30 30 | | | kV kV | | | | | |
| R _{DYN} | Dynamic Resistance Positive Negative | | | 1.5 0.9 | | Ω | | | | | |
| f _c | Cut-off Frequency $Z_{\text{SOURCE}} = 50\Omega$, $Z_{\text{LOAD}} = 50\Omega$ | R = 100Ω, C = 25pF | | 70 | | MHz | | | | | |

Note 1: $T_A = 25^{\circ}C$ unless otherwise specified. Note 2: ESD applied to input and output pins with respect to GND, one at a time.

Performance Information

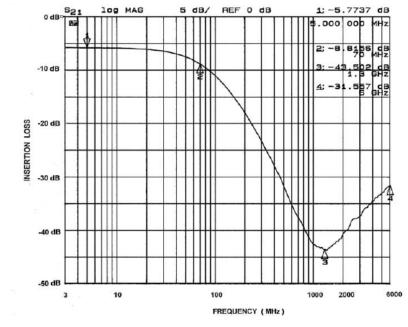


Figure 1. A1-C1 EMI Filter Performance

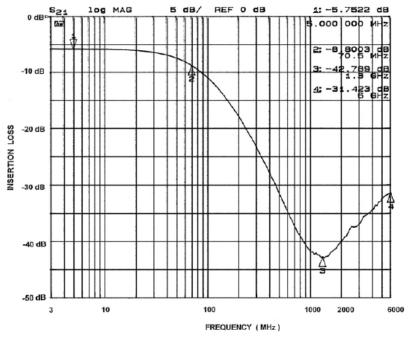


Figure 2. A2-C2 EMI Filter Performance

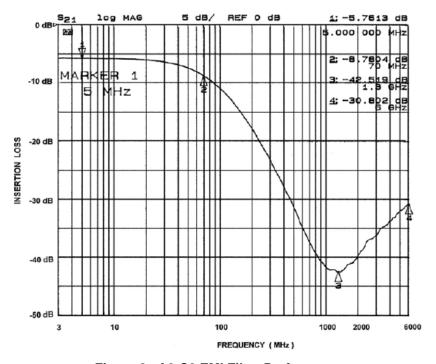


Figure 3. A3-C3 EMI Filter Performance

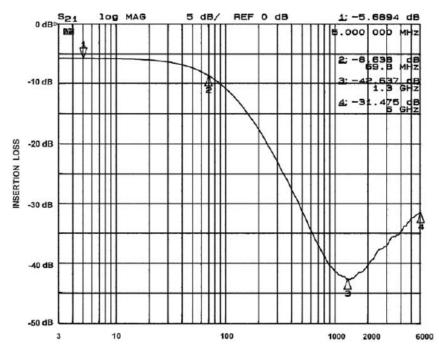


Figure 4. A4-C4 EMI Filter Performance

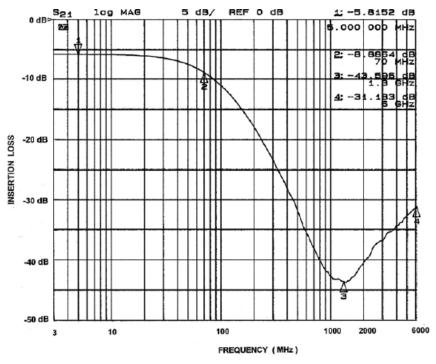


Figure 5. A5-C5 EMI Filter Performance

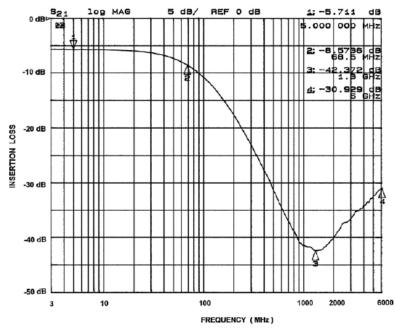


Figure 6. A6-C6 EMI Filter Performance

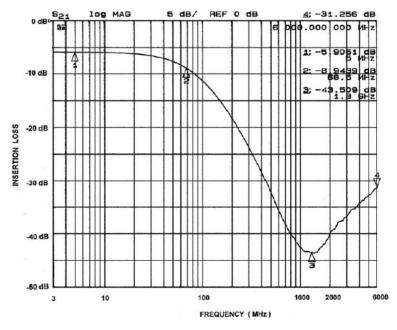


Figure 7. A7-C7 EMI Filter Performance

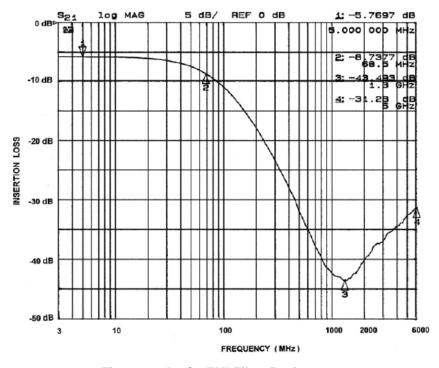


Figure 8. A8-C8 EMI Filter Performance

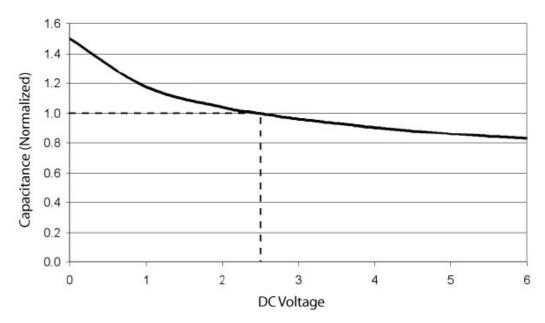


Figure 9. Filter Capacitance vs. Input Voltage over Temperature (normalized to capacitance at 2.5VDC and 25°C)

Figure 9.

Application Information

| PARAMETER | VALUE |
|--|------------------------------|
| Pad Size on PCB | 0.240mm |
| Pad Shape | Round |
| Pad Definition | Non-Solder Mask defined pads |
| Solder Mask Opening | 0.290mm Round |
| Solder Stencil Thickness | 0.125mm - 0.150mm |
| Solder Stencil Aperture Opening (laser cut, 5% tapered walls) | 0.300mm Round |
| Solder Flux Ratio | 50/50 by volume |
| Solder Paste Type | No Clean |
| Pad Protective Finish | OSP (Entek Cu Plus 106A) |
| Tolerance — Edge To Corner Ball | <u>+</u> 50μm |
| Solder Ball Side Coplanarity | <u>+</u> 20μm |
| Maximum Dwell Time Above Liquidous | 60 seconds |
| Maximum Soldering Temperature for Lead-free Devices using a Lead-free Solder Paste | 260°C |

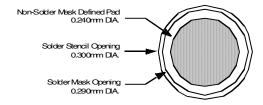


Figure 8. Recommended Non-Solder Mask Defined Pad Illustration

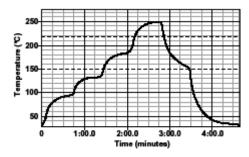


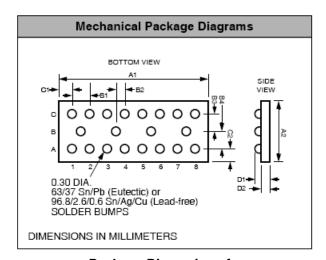
Figure 9. Lead-free (SnAgCu) Solder Ball Reflow Profile

Mechanical Details

CM1405-01 Mechanical Specifications

The package dimensions for the CM1405-01 are presented below.

| PACKAGE DIMENSIONS | | | | | | | | | |
|---------------------|------------------------------------|-------------|-------|--------|--------|--------|--|--|--|
| Pack | age | Custom CSP | | | | | | | |
| Bun | nps | | | 20 | | | | | |
| Dim | М | illimete | ers | | Inches | | | | |
| Dilli | Min | Nom | Max | Min | Nom | Max | | | |
| A 1 | 3.955 | 4.000 | 4.045 | 0.1557 | 0.1575 | 0.1593 | | | |
| A2 | 1.413 | 1.458 | 1.503 | 0.0556 | 0.0574 | 0.0592 | | | |
| B1 | 0.495 0.500 0.500 | | 0.505 | 0.0195 | 0.0197 | 0.0199 | | | |
| B2 | 0.245 | 0.250 0.255 | | 0.0096 | 0.0098 | 0.0100 | | | |
| В3 | 0.430 | 0.435 | 0.440 | 0.0169 | 0.0171 | 0.0173 | | | |
| B4 | 0.430 | 0.435 | 0.440 | 0.0169 | 0.0171 | 0.0173 | | | |
| C1 | 0.200 | 0.250 | 0.300 | 0.0079 | 0.0098 | 0.0118 | | | |
| C2 | 0.244 | 0.294 | 0.344 | 0.0096 | 0.0116 | 0.0135 | | | |
| D1 | 0.562 | 0.606 | 0.650 | 0.0221 | 0.0239 | 0.0256 | | | |
| D2 0.356 | | 0.381 | 0.406 | 0.0140 | 0.0150 | 0.0160 | | | |
| # per tape and reel | | 3500 pieces | | | | | | | |
| | Controlling dimension: millimeters | | | | | | | | |



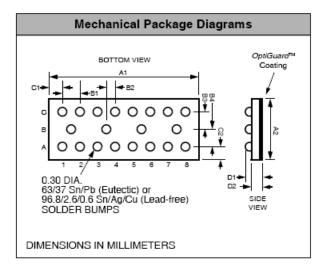
Package Dimensions for CM1405-01 Chip Scale Package

Mechanical Details (cont'd)

CM1405-03 Mechanical Specifications

The package dimensions for the CM1405-03 are presented below.

| PACKAGE DIMENSIONS | | | | | | | | | |
|---------------------|------------------------------------|-------------|-------|--------|--------|--------|--|--|--|
| Pack | age | Custom CSP | | | | | | | |
| Burr | nps | | | 20 | | | | | |
| Dim | М | illimete | rs | | Inches | | | | |
| | Min | Nom | Max | Min | Nom | Max | | | |
| A 1 | 3.955 | 4.000 | 4.045 | 0.1557 | 0.1575 | 0.1593 | | | |
| A2 | 1.413 1.458 1.503 | | 1.503 | 0.0556 | 0.0574 | 0.0592 | | | |
| B1 | B1 0.495 0.500 0.500 | | 0.505 | 0.0195 | 0.0197 | 0.0199 | | | |
| B2 | 0.245 | 0.250 0.25 | | 0.0096 | 0.0098 | 0.0100 | | | |
| В3 | 0.430 | 0.435 | 0.440 | 0.0169 | 0.0171 | 0.0173 | | | |
| B4 | 0.430 | 0.435 | 0.440 | 0.0169 | 0.0171 | 0.0173 | | | |
| C1 | 0.200 | 0.250 | 0.300 | 0.0079 | 0.0098 | 0.0118 | | | |
| C2 | 0.244 | 0.294 | 0.344 | 0.0096 | 0.0116 | 0.0135 | | | |
| D1 | 0.575 | 0.644 | 0.714 | 0.0226 | 0.0254 | 0.0281 | | | |
| D2 0.368 | | 0.419 | 0.470 | 0.0145 | 0.0165 | 0.0185 | | | |
| # per tape and reel | | 3500 pieces | | | | | | | |
| | Controlling dimension: millimeters | | | | | | | | |



Package Dimensions for CM1405-03 Chip Scale Package

CSP Tape and Reel Specifications

| PART NUMBER | CHIP SIZE (mm) | POCKET SIZE (mm) B _o X A _o X K _o | TAPE WIDTH W | REEL DIAMETER | QTY PER REEL | P _o | P ₁ |
|-------------|------------------------|--|-----------------|------------------|-----------------|----------------|----------------|
| CM1405-01 | 4.00 X 1.46 X 0.606 | 4.11 X 1.57 X 0.76 | 12mm | 330mm (13") | 3500 | 4mm | 4mm |
| CM1405-03 | 4.00 X 1.46 X 0.644 | 4.11 X 1.57 X 0.76 | 12mm | 330mm (13") | 3500 | 4mm | 4mm |

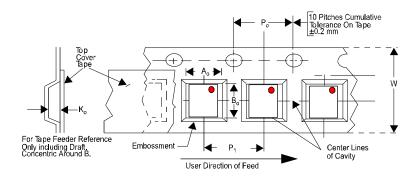


Figure 13. Tape and Reel Mechanical Data

CM1405

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